1. A plasma CVD apparatus comprising:

a vacuum chamber;

an introducing means for introducing a gas into the vacuum chamber; an exhaust means for exhausting the gas from the vacuum chamber to an

an electrode for supplying an electric energy inside the vacuum chamber; a supporting means for supporting a substrate opposing the electrode, wherein an introducing port is located adjacent to an electrode side surface of

10 the substrate,

outside;

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wherein a plurality of openings are located on a surface of the electrode opposing the substrate,

wherein the gas is exhausted from the plurality of openings to the outside of the vacuum chamber.

- 2. An apparatus according to claim 1, further comprising:
 a transporting means for transporting continuously a flexible substrate.
- 3. An apparatus according to claim 1,

wherein each of the plurality of openings is circular,

wherein the plurality of openings are located on the surface of the electrode at constant intervals.

- 4. An apparatus according to claim 1, wherein the electrode is a mesh-like plate.
- 5. A discharge electrode comprising:

two electrodes opposing each other,

wherein a plurality of openings are located on a surface of one of the two electrodes,

wherein a gas is exhausted from the plurality of openings.